

HSP

TECHNICAL SPECS:

Current Rating:3.0AMP
Contact Resistance:20mΩ Max
Insulation Resistance:1000MΩ Min
Withstanding Voltage:1000V AC/Minute
Operation Temperature:-40°C to +105°C
Contact Material:Brass
Contact plating:Au or Sn over Ni
Insulator Material:PB+30%G.F.(UL94V-0)

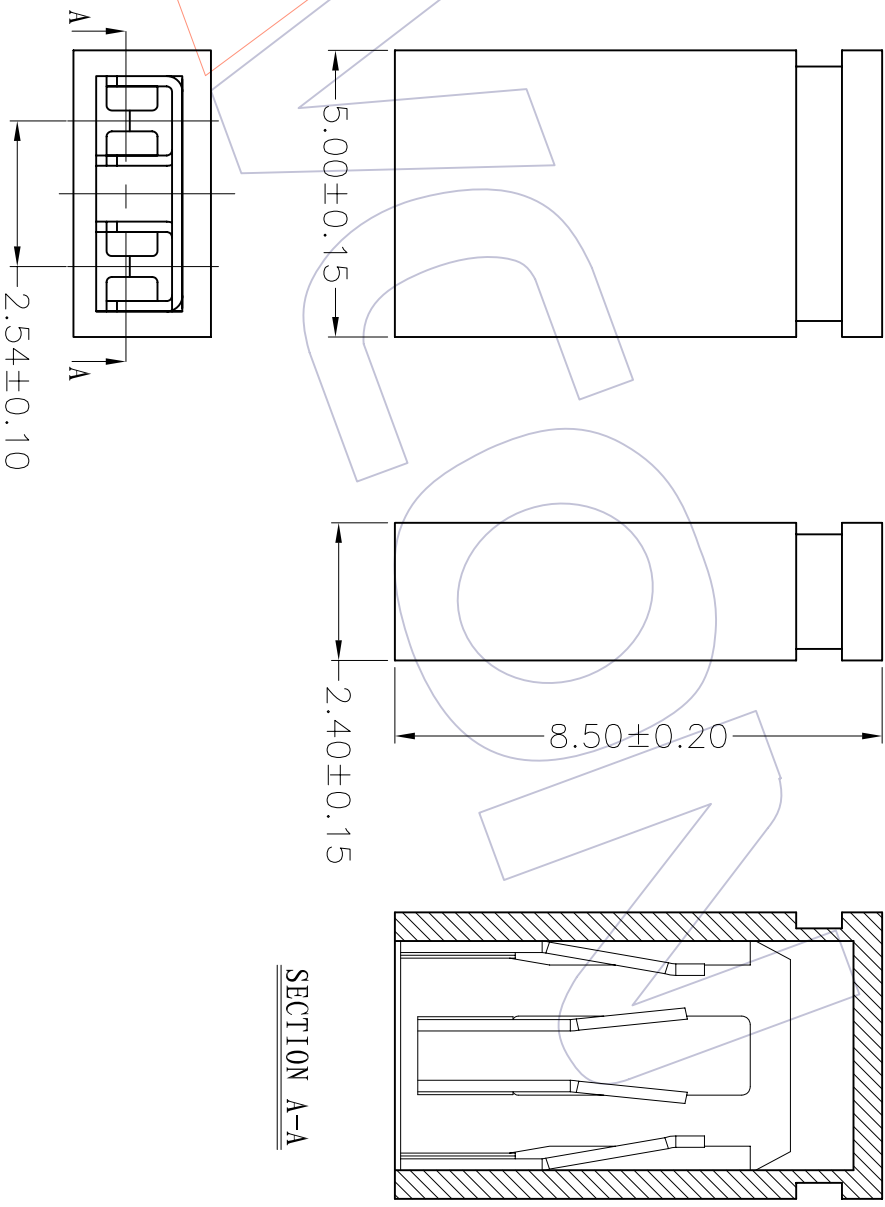
Ordering Information

3710 - 85 01 C XX X 01

Housing shape
O=open
C=close

Contact Plating
G0=Gold Flash
G1=3u"Gold
G2=5u"Gold
G3=10u"Gold
G4=15u"Gold
G5=30u"Gold
S0=Gold Flash/Ni
S1=3u"Gold/Ni
S2=5u"Gold/Ni
S3=10u"Gold/Ni
S4=15u"Gold/Ni
S5=30u"Gold/Ni
SN=Tin

Colour
B=Black
R=Red
Y=Yellow



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW		WEIXD	08/10/29	SCALE		PART NO.	TITLE:
					XXX	±0.30	DESIGN	UNIT			1:1	mm		
A0	08/10/29	NEW			XXX	±0.25	CHECK	CHECK			1/1	3710-8501CXXX01	2.54mm MINI JUMPER CLOSE TYPE H=8.5	
					Angle	± .3'	APPROVE	PROJ.						

WCON 维峰五金电子有限公司
WAVE HARDWARE ELECTRONICS CO. LTD

3710-8501CXXX01

2.54mm MINI JUMPER CLOSE TYPE H=8.5